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MARKING DIAGRAMS

TinyLogic ULP-A Dual Buffer (Open-Drain Output)

NC7WV07

The NC7WV07 is a dual buffer with open-drain output in tiny footprint packages. The device is designed to operate for $V_{CC} = 0.9 \text{ V}$ to 3.6 V.

Features

- Designed for 0.9 V to 3.6 V V_{CC} Operation
- 1.6 ns t_{PD} at 3.3 V (Typ)
- Inputs/Outputs Over-Voltage Tolerant up to 3.6 V
- I_{OFF} Supports Partial Power Down Protection
- Source/Sink 24 mA at 3.3 V
- Available in SC-88 and MicroPak[™] Packages
- These Devices are Pb–Free, Halogen Free/BFR Free and are RoHS Compliant

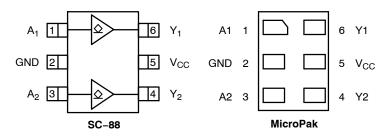


Figure 1. Pinout Diagrams (Top Views)



Figure 2. Logic Symbol

PIN ASSIGNMENT

Pin	Function
1	A1
2	GND
3	A2
4	Y2
5	V _{CC}
6	Y1



XY

Ζ



XXX = Specific Devic Code M = Date Code* = Pb-Free Package

SC-88 CASE 419AD

= = FD-ITee Fackage

(Note: Microdot may be in either location)

*Date Code orientation and/or position may vary depending upon manufacturing location.



CC	= Specific Device Code	

- KK = 2-Digit Lot Run Traceability Code
 - = 2-Digit Date Code
 - = Assembly Plant Code

ORDERING INFORMATION

See detailed ordering, marking and shipping information on page 6 of this data sheet.

NOTE: Some of the devices on this data sheet have been **DISCONTINUED**. Please refer to the table on page 6.

FUNCTION TABLE

A Input	Y Output
L	L
Н	Z

Z = High Impedance

Semiconductor Components Industries, LLC, 2006 July, 2024 – Rev. 5

MAXIMUM RATINGS

Symbol	Characteristics	Value	Unit
V _{CC}	DC Supply Voltage	-0.5 to +4.3	V
V _{IN}	DC Input Voltage	-0.5 to +4.3	V
V _{OUT}	DC Output Voltage Active-Mode (High or Low State) Tri-State Mode (Note Power-Down Mode (V _{CC} = 0		V
I _{IK}	DC Input Diode Current V _{IN} < Gi	ND –50	mA
I _{OK}	DC Output Diode Current V _{OUT} < G	ND –50	mA
I _{OUT}	DC Output Source/Sink Current	±50	mA
I_{CC} or I_{GND}	DC Supply Current per Supply Pin or Ground Pin	±50	mA
T _{STG}	Storage Temperature Range	-65 to +150	°C
ΤL	Lead Temperature, 1 mm from Case for 10 Seconds	260	°C
ТJ	Junction Temperature Under Bias	+150	°C
θ_{JA}	Thermal Resistance (Note 2) SC- MicroF		°C/W
PD	Power Dissipation in Still Air SC- MicroF		mW
MSL	Moisture Sensitivity	Level 1	-
F _R	Flammability Rating Oxygen Index: 28 to 34	UL 94 V-0 @ 0.125 in	-
V_{ESD}	ESD Withstand Voltage (Note 3) Human Body Mo Charged Device Mo		V
I _{Latchup}	Latchup Performance (Note 4)	±100	mA

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality Should not be assumed, damage may occur and reliability may be affected.
Applicable to devices with outputs that may be tri-stated.
Measured with minimum pad spacing on an FR4 board, using 10 mm-by-1 inch, 2 ounce copper trace no air flow per JESD51-7.
HBM tested to EIA / JESD22-A114-A. CDM tested to JESD22-C101-A. JEDEC recommends that ESD qualification to EIA/JESD22-A115A

(Machine Model) be discontinued.4. Tested to EIA/JESD78 Class II.

NC7WV07

RECOMMENDED OPERATING CONDITIONS

Symbol	Parameter	Min	Max	Unit
V _{CC}	Positive DC Supply Voltage	0.9	3.6	V
V _{IN}	DC Input Voltage	0	3.6	V
V _{OUT}	DC Output Voltage Active-Mode (High or Low State) Tri-State Mode (Note 5) Power-Down Mode (V _{CC} = 0 V)	0 0 0	V _{CC} 3.6 3.6	
T _A	Operating Temperature Range	-40	+85	°C
t _r , t _f	Input Transition Rise and Fall Time $$V_{CC}$$ = 3.3 V \pm 0.3 V	0	10	ns/V

Functional operation above the stresses listed in the Recommended Operating Ranges is not implied. Extended exposure to stresses beyond the Recommended Operating Ranges limits may affect device reliability. 5. Applicable to devices with outputs that may be tri-stated.

DC ELECTRICAL CHARACTERISTICS

				Т	A = 25°	С	T _A = -40°0	C to +85°C	
Symbol	Parameter	Condition	V _{CC} (V)	Min	Тур	Max	Min	Max	Unit
V _{IH}	High-Level Input		0.9	-	0.5	-	-	-	V
	Voltage	70ltage 1.1 to 1.3	0.65 x V _{CC}	-	-	0.65 x V _{CC}	_		
			1.4 to 1.6	0.65 x V _{CC}	-	-	0.65 x V _{CC}	_]
		1.65 to 1.95 2.3 to <2.7	1.65 to 1.95	0.65 x V _{CC}	-	-	0.65 x V _{CC}	_]
			2.3 to <2.7	1.6	-	-	1.6	-	
			2.7 to 3.6	2.0	-	-	2.0	-	
VIL	Low-Level Input		0.9	-	0.5	-	-	-	V
	voitage	Voltage 1.1 to 1.3	1.1 to 1.3	-	-	0.35 x V _{CC}	-	0.35 x V _{CC}	-
			1.4 to 1.6	-	-	0.35 x V _{CC}	-	0.35 x V _{CC}	
			1.65 to 1.95	-	-	0.35 x V _{CC}	-	0.35 x V _{CC}	
			2.3 to <2.7	-	-	0.7	_	0.7	
			2.7 to 3.6	-	-	0.8	_	0.8	

NC7WV07

DC ELECTRICAL CHARACTERISTICS (continued)

					T _A = 25°0	C	T _A = -40°	C to +85°C	
Symbol	Parameter	Condition	V _{CC} (V)	Min	Тур	Max	Min	Max	Unit
V _{OL}	Low-Level	$V_{IN} = V_{IH} \text{ or } V_{IL}$							V
	Output Voltage	I _{OL} = 100 μA	0.9	_	0.1	-	-	-	
			1.1 to 1.3	_	-	0.1	-	0.1	
			1.4 to 1.6	_	-	0.1	-	0.1	
			1.65 to 1.95	-	-	0.2	-	0.2	
	2.3 t	2.3 to < 2.7	-	-	0.2	-	0.2		
			2.7 to 3.6	-	-	0.2	-	0.2	
		I _{OL} = 2 mA	1.1 o 1.3	_	-	0.25 x V _{CC}	-	0.25 x V _{CC}	
		I _{OL} = 4 mA 1.4 to 1.6	1.4 to 1.6	_	-	0.25 x V _{CC}	-	0.25 x V _{CC}	
		I _{OL} = 6 mA	1.65 to 1.95	-	-	0.3	-	0.3	
		I _{OL} = 12 mA	2.3 to <2.7	-	-	0.4	-	0.4	
			2.7 to 3.6	-	-	0.4	-	0.4	
		I _{OL} = 18 mA	2.3 to <2.7	-	-	0.6	-	0.6	
			2.7 to 3.6	-	-	0.4	-	0.4	
		I _{OL} = 24 mA	2.7 to 3.6	-	-	0.55	-	0.55	
I _{IN}	Input Leakage Current	$V_{IN} = 0 V \text{ to } 3.6 V$	0.9 to 3.6	-	-	±0.1	-	±0.5	μΑ
I _{OFF}	Power Off Leakage Current	$V_{IN} = 0 V$ to 3.6 V or $V_{OUT} = 0 V$ to 3.6 V	0	_	-	0.5	-	0.5	μΑ
I _{CC}	Quiescent Supply Current	$V_{IN} = V_{CC}$ or GND	0.9 to 3.6	_	-	0.9	-	0.9	μA

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

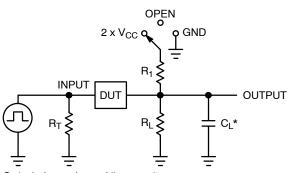
AC ELECTRICAL CHARACTERISTICS

				1	r _A = 25°C)	T _A = -40°C	C to +85°C		
Symbol	Parameter	Condition	V _{CC} (V)	Min	Тур	Max	Min	Мах	Unit	
	Propagation Delay, A to Y (Figures 3 and 4)	$\begin{array}{l} R1=R_{L}=1\ k\Omega,\\ C_{L}=30\ pF \end{array}$	0.9	-	15.9	-	-	-	ns	
t _{PLZ}	A to Y (Figures 3 and 4)		Ο <u>[</u> = 30 μ	0L = 30 pi	1.1 to 1.3	-	5.4	15.6	-	18.6
			1.4 to 1.6	-	3.6	8.7	-	9.7		
			1.65 to 1.95	-	2.4	6.0	-	6.8		
			2.3 to 2.7	-	1.9	3.6	-	4.7		
			2.7 to 3.6	-	1.6	3.3	-	4.0		

CAPACITIVE CHARACTERISTICS

Symbol	Parameter	Test Condition	Typ (T _A = 25°C)	Unit
C _{IN}	Input Capacitance	V _{CC} = 0 V	2.0	pF
C _{OUT}	Output Capacitance	$V_{CC} = 0 V$	6.5	pF
C _{PD}	Power Dissipation Capacitance (Note 6)	f = 10 MHz, V_{CC} = 0.9 to 3.6 V, V_{IN} = 0 V or V_{CC}	10.0	pF

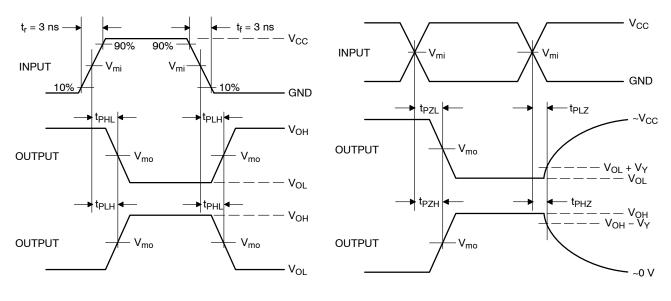
6. C_{PD} is defined as the value of the internal equivalent capacitance which is calculated from the operating current consumption without load. Average operating current can be obtained by the equation $I_{CC(OPR)} = C_{PD} \bullet V_{CC} \bullet f_{in} + I_{CC}$. C_{PD} is used to determine the no-load dynamic power consumption: $P_D = C_{PD} \bullet V_{CC}^2 \bullet f_{in} + I_{CC} \bullet V_{CC}$.



Test	Switch Position
t _{PLH} / t _{PHL}	Open
t _{PLZ} / t _{PZL}	6 V @ Vcc = 3.0–3.6 V; 2 x Vcc @ Vcc = 0.9–2.7 V
t _{PHZ} / t _{PZH}	GND

 C_L includes probe and jig capacitance R_T is Z_{OUT} of pulse generator (typically 50 $\Omega)$ f = 1 MHz





V _{CC} , V	V _{mi} , V	V _{mo} , V	V _Y , V
0.9	V _{CC} / 2	V _{CC} / 2	0.1
1.1 to 1.3	V _{CC} / 2	V _{CC} / 2	0.1
1.4 to 1.6	V _{CC} / 2	V _{CC} / 2	0.1
1.65 to 1.95	V _{CC} / 2	V _{CC} / 2	0.15
2.3 to 2.7	V _{CC} / 2	V _{CC} / 2	0.15
3.0 to 3.6	1.5	1.5	0.3

Figure 4. Switching Waveforms

ORDERING INFORMATION

Device	Package	Marking	Pin 1 Orientation (See below)	Shipping [†]
NC7WV07P6X	SC-88	V07	Q4	3000 / Tape & Reel

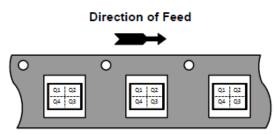
DISCONTINUED (Note 7)

NC7WV07L6X	MicroPak	BC	Q4	5000 / Tape & Reel

+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

7. **DISCONTINUED:** This device is not recommended for new design. Please contact your **onsemi** representative for information. The most current information on this device may be available on <u>www.onsemi.com</u>.

PIN 1 ORIENTATION IN TAPE AND REEL



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SIP6 1.45X1.0 CASE 127EB ISSUE O

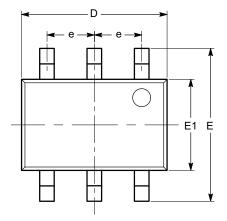
DATE 31 AUG 2016



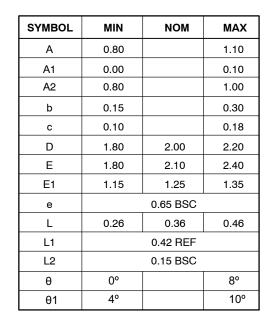
SC-88 (SC-70 6 Lead), 1.25x2 CASE 419AD ISSUE A

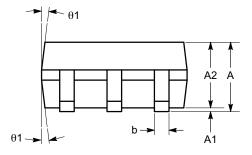
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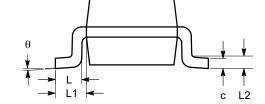


SIDE VIEW

Notes:

(1) All dimensions are in millimeters. Angles in degrees.

(2) Complies with JEDEC MO-203.



END VIEW

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